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40 V, 200 mA NPN/PNP switching transistor Rev. 01 — 31 August 2009

Product data sheet

1. Product profile

1.1 General description

NPN/PNP double switching transistor in a SOT666 ultra small and flat lead Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package	0		PNP/PNP	
	NXP	JEITA	complement	complement	
PMBT3946VPN	SOT666	-	PMBT3904VS	PMBT3906VS	

1.2 Features

- Double general-purpose switching transistor
- Board-space reduction
- Ultra small and flat lead SMD plastic package

1.3 Applications

General-purpose switching and amplification

1.4 Quick reference data

Table 2.	Quick reference data							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
Per transistor; for the PNP transistor with negative polarity								
V_{CEO}	collector-emitter voltage	open base	-	-	40	V		
I _C	collector current		-	-	200	mA		
TR1 (NPN	TR1 (NPN)							
h _{FE}	DC current gain	$V_{CE} = 1 V;$ $I_{C} = 10 mA$	100	180	300			
TR2 (PNF	TR2 (PNP)							
h _{FE}	DC current gain	$V_{CE} = -1 V;$ $I_{C} = -10 mA$	100	180	300			



40 V, 200 mA NPN/PNP switching transistor

2. Pinning information

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1		
3	collector TR2		
4	emitter TR2	0	
5	base TR2		
6	collector TR1	1 2 3	1 2 3
			sym019

3. Ordering information

Table 4. Ordering	informatio	n	
Type number	Package		
	Name	Description	Version
PMBT3946VPN	-	plastic surface-mounted package; 6 leads	SOT666

4. Marking

Table 5.	Marking codes	
Type num	ber	Marking code
PMBT394	6VPN	ZE

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		•••				
Symbol	Parameter	Conditions	Min	Max	Unit	
TR1 (NPN	l)					
V _{CBO}	collector-base voltage	open emitter	-	60	V	
TR2 (PNF	?)					
V _{CBO}	collector-base voltage	open emitter	-	-40	V	
Per transistor; for the PNP transistor with negative polarity						
V _{CEO}	collector-emitter voltage	open base	-	40	V	
V_{EBO}	emitter-base voltage	open collector	-	6	V	
I _C	collector current		-	200	mA	
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	200	mA	
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms	-	100	mA	
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[2] _	240	mW	

40 V, 200 mA NPN/PNP switching transistor

Table 6.	Limiting	values	continued
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In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per devic	e				
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1][2] _	360	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Reflow soldering is the only recommended soldering method.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1][2]</u> _	-	521	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	100	K/W
Per devic	e					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1][2] _	-	347	K/W

[1] Reflow soldering is the only recommended soldering method.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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PMBT3946VPN

40 V, 200 mA NPN/PNP switching transistor



7. Characteristics

Table 8.Characteristics

 $T_{amb} = 25 \circ C$ unless otherwise specified.

anno —•						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (NPN	۷)					
I _{CBO}	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 6 V; I_C = 0 A$	-	-	50	nA
h _{FE}	DC current gain	$V_{CE} = 1 V$				
		I _C = 0.1 mA	60	180	-	
		$I_{\rm C} = 1 \rm{mA}$	80	180	-	
		I _C = 10 mA	100	180	300	
		I _C = 50 mA	60	105	-	
		I _C = 100 mA	30	50	-	
V _{CEsat}	collector-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 1 \text{ mA}$	-	75	200	mV
	saturation voltage	$I_{C} = 50 \text{ mA}; I_{B} = 5 \text{ mA}$	-	120	300	mV
V _{BEsat}	base-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 1 \text{ mA}$	650	750	850	mV
	saturation voltage	$I_{C} = 50 \text{ mA}; I_{B} = 5 \text{ mA}$	-	850	950	mV

40 V, 200 mA NPN/PNP switching transistor

Table 8. Characteristics ...continued

$T_{amb} = 25 \circ C$ unless otherwise specified

	°C unless otherwise sp					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
t _d	delay time	$V_{CC} = 3 \text{ V}; \text{ I}_{C} = 10 \text{ mA};$	-	-	35	ns
t _r	rise time	$I_{Bon} = 1 \text{ mA};$ $I_{Boff} = -1 \text{ mA}$	-	-	35	ns
t _{on}	turn-on time		-	-	70	ns
t _s	storage time		-	-	200	ns
t _f	fall time		-	-	50	ns
t _{off}	turn-off time		-	-	250	ns
C _c	collector capacitance	$V_{CB} = 5 V; I_E = i_e = 0 A;$ f = 1 MHz	-	-	4	рF
C _e	emitter capacitance	$\label{eq:Veb} \begin{split} V_{EB} &= 500 \text{ mV};\\ I_C &= i_c = 0 \text{ A}; \text{ f} = 1 \text{ MHz} \end{split}$	-	-	8	рF
f _T	transition frequency	V_{CE} = 20 V; I_C = 10 mA; f = 100 MHz	300	-	-	MHz
NF	noise figure	$\label{eq:VCE} \begin{split} V_{CE} &= 5 \text{ V}; \text{ I}_{C} = 100 \ \mu\text{A}; \\ R_{S} &= 1 \ k\Omega; \\ \text{f} &= 10 \ \text{Hz} \ \text{to} \ 15.7 \ \text{kHz} \end{split}$	-	-	5	dB
TR2 (PNF	?)					
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_E = 0 \text{ A}$	-	-	-50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -6 V; I_C = 0 A$	-	-	-50	nA
h _{FE}	DC current gain	$V_{CE} = -1 V$				
		I _C = -0.1 mA	60	180	-	
		$I_{\rm C} = -1 \rm{mA}$	80	180	-	
		$I_{\rm C} = -10 {\rm mA}$	100	180	300	
		I _C = -50 mA	60	130	-	
		$I_{\rm C} = -100 \rm{mA}$	30	50	-	
V _{CEsat}	collector-emitter	$I_{C} = -10 \text{ mA}; I_{B} = -1 \text{ mA}$	-	-100	-250	mV
	saturation voltage	$I_{\rm C} = -50 \text{ mA}; I_{\rm B} = -5 \text{ mA}$	-	-165	-400	mV
V _{BEsat}	base-emitter	$I_{C} = -10 \text{ mA}; I_{B} = -1 \text{ mA}$	-	-750	-850	mV
	saturation voltage	$I_{\rm C} = -50 \text{ mA}; I_{\rm B} = -5 \text{ mA}$	-	-850	-950	mV
t _d	delay time	$V_{CC} = -3 V;$	-	-	35	ns
t _r	rise time	$I_{\rm C} = -10 \text{ mA};$	-	-	35	ns
t _{on}	turn-on time	$I_{Bon} = -1 \text{ mA};$ $I_{Boff} = 1 \text{ mA}$	-	-	70	ns
t _s	storage time	20	-	-	225	ns
t _f	fall time		-	-	75	ns
t _{off}	turn-off time		-	-	300	ns
C _c	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = -5 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ \text{f} = 1 \text{ MHz} \end{array}$	-	-	4.5	pF

40 V, 200 mA NPN/PNP switching transistor

Table 8. Characteristics ...continued

$T_{amb} = 25 ^{\circ}C$ unless otherwise specified.						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _e	emitter capacitance	$V_{EB} = -500 \text{ mV};$ $I_C = i_c = 0 \text{ A}; \text{ f} = 1 \text{ MHz}$	-	-	10	pF
f _T	transition frequency	$V_{CE} = -20 \text{ V};$ $I_{C} = -10 \text{ mA};$ f = 100 MHz	250	-	-	MHz
NF	noise figure	$\label{eq:V_CE} \begin{array}{l} V_{CE} = -5 \ V; \\ I_C = -100 \ \mu \text{A}; R_S = 1 \ \text{k}\Omega; \\ f = 10 \ \text{Hz} \ \text{to} \ 15.7 \ \text{kHz} \end{array}$	-	-	4	dB



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40 V, 200 mA NPN/PNP switching transistor

8. Test information



40 V, 200 mA NPN/PNP switching transistor

9. Package outline



10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number Package		Description	Packing	Packing quantity	
			4000	8000	
PMBT3946VPN	SOT666	2 mm pitch, 8 mm tape and reel	-	-315	
		4 mm pitch, 8 mm tape and reel	-115	-	

[1] For further information and the availability of packing methods, see Section 14.

40 V, 200 mA NPN/PNP switching transistor

11. Soldering



40 V, 200 mA NPN/PNP switching transistor

12. Revision history

Table 10. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
PMBT3946VPN_1	20090831	Product data sheet	-	-	

40 V, 200 mA NPN/PNP switching transistor

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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PMBT3946VPN_1 Product data sheet

40 V, 200 mA NPN/PNP switching transistor

15. Contents

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 10
9	Package outline 11
10	Packing information
11	Soldering 12
12	Revision history 13
13	Legal information 14
13.1	Data sheet status 14
13.2	Definitions 14
13.3	Disclaimers 14
13.4	Trademarks 14
14	Contact information 14
15	Contents 15

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